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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of **Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

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Details	
Product Status	Obsolete
Core Processor	EC000
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	8MHz
Co-Processors/DSP	· .
RAM Controllers	-
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	-
Package / Case	68-LCC (J-Lead)
Supplier Device Package	68-PLCC (24.21x24.21)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mc68ec000ei8

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



The primary features of the MC68SEC000 embedded processor include the following:

- Direct Replacement for the MC68EC000
 - Pin-for-pin compatibility with the MC68EC000 in the plastic QFP and TQFP packages
 - Vast selection of existing third-party development tools for the MC68EC000 support the MC68SEC000
 - Software written for the MC68EC000 will run unchanged on the MC68SEC000
- Power Management
 - Low-power HCMOS technology
 - Static design allows for stopping the processor clock
 - 3.3V or 5V operation
 - Typical 0.5µÅ current consumption at 3.3V in sleep mode
- Software Strength
 - Fully upward object-code compatible with other M68000 Family products
 - M68000 architecture allows effective assembly code with a C compiler
- Upgrade
 - Fully upward code-compatible with higher performance 680x0 and 68300 Family members
 - ColdFire[®] code-compatible with minor modifications

1. MC68HC000

The primary benefit of the MC68HC000 is reduced power consumption. The device dissipates less power (by an order of magnitude) than the NMOS MC68000.

The MC68HC000 is an implementation of the M68000 16/-32 bit microprocessor architecture. The MC68HC000 has a 16-bit data bus implementation of the MC68000 and is upward code-compatible with the MC68010 and the MC68020 32-bit implementation of the architecture.

1.1 MC68HC001

The MC68HC001 provides a functional extension to the MC68HC000 HCMOS 16-/32-bit microprocessor with the addition of statically selectable 8- or 16-bit data bus operation. The MC68HC001 is object-code compatible with the MC68HC000. You can migrate code written for the MC68HC001 without modification to any member of the M68000 Family.

1.2 MC68EC000

The MC68EC000 is an economical high-performance embedded controller designed to suit the needs of the cost-sensitive embedded-controller market. The HCMOS MC68EC000 has an internal 32-bit architecture that is supported by a statically selectable 8- or 16-bit data bus. This architecture provides a fast and efficient processing device that can satisfy the requirements of sophisticated applications based on high-level languages.

The MC68EC000 is fully object-code compatible with the MC68000. You can migrate code written for the MC68EC000 without modification to any member of the M68000 Family.

The MC68EC000 brings the performance level of the M68000 Family to cost levels previously associated with 8-bit microprocessors. The MC68EC000 benefits from the rich M68000 instruction set and its related high code density with low memory bandwidth requirements.



1.3 MC68SEC000

The MC68SEC000 is a cost-effective static embedded processor engineered for low-power applications. In addition to providing the substantial cost and performance benefits of the MC68EC000, the low-power mode of the MC68SEC000 provides significant advantages in power consumption and power management. The typical current consumption of the MC68SEC000 is only 0.5μ A in static standby mode and 15.0mA in normal 3.3V operation. The MC68SEC000 operates in either 3.3V or 5.0V systems. The remarkably low power consumption, small footprint packages, and static implementation are combined in the MC68SEC000 for low-power applications such as portable measuring equipment, electronic games, and battery-operated hand-held consumer products.

The HCMOS MC68SEC000's static architecture is a direct replacement for the MC68EC000, which offers the lowest cost entry point to 32-bit processing. The internal 32-bit architecture provides fast and efficient processing that satisfies the requirements of sophisticated applications based on high-level languages.

All of the existing third-party developer tools widely available for the MC68EC000 will directly support the MC68SEC000. You can find detailed descriptions of these tools in the *High Performance Embedded Systems Source Catalog.*



2.0 SIGNAL DESCRIPTION

Change Figure 3-3 on Page 3-2.

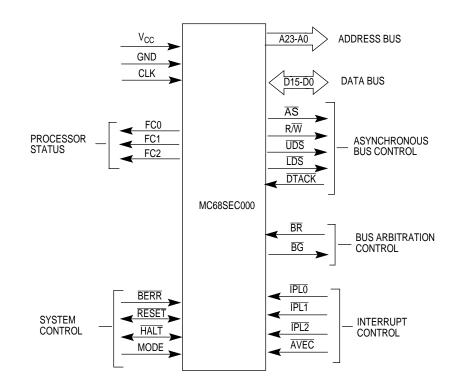


Figure 1. Input and Output Signals (MC68EC000 and MC68SEC000)

2.1 Data Bus (D15-D0)

In Section 3.2 on page 3-4, replace "The MC68EC000 and MC68HC001 use D7-D0 in 8-bit mode, and D15-D8 are undefined." with "Using the MC68HC001, MC68EC000, and MC68SEC000 mode pin, you can statically select either 8- or 16-bit modes for data transfer. The MC68EC000, MC68SEC000, and MC68HC001 use D7-D0 in 8-bit mode. D15-D8 are undefined."

2.2 Bus Arbitration Control

In Section 3.4 on page 3-5, the sentence "In the 48-pin version of the MC68008 and MC68EC000, no pin is available for the bus grant acknowledge signal; this microprocessor uses a two-wire bus arbitration scheme." should read "In the 64-pin MC68EC000 and MC68SEC000, no pin is available for the bus grant acknowledge signal. These microprocessors use a two-wire bus arbitration scheme."

2.3 System Control

The Mode subsection heading of Section 3.6 on page 3-7 should read "Mode (MODE) (MC68HC001/ 68EC000/68SEC000)."

2.4 MC68SEC000 Low-Power Mode

Add the following to Sections 4 and 5, Bus Operation.

The MC68SEC000 has been redesigned to provide fully static- and low-power operation. This section describes the recommended method for placing the MC68SEC000 into a low-power mode to reduce the

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power consumption to its quiescent value¹ while maintaining the internal state of the processor. The low-power mode described below will be routinely tested as part of the MC68SEC000 test vectors provided by Motorola.

To successfully enter the low-power mode, the MC68SEC000 must first be in the supervisor mode. A recommended method for entering the low-power mode is to use the TRAP instruction, which causes the processor to begin exception processing, thus entering the supervisor mode. External circuitry should accomplish the following steps during the trap routine:

 Externally detect a write to the low-power address. You select this address which can be any address in the 16 Mbyte addressing range of the MC68SEC000. A write to the low-power address can be detected by polling A23–A0, R/W, and FC2–FC0. When the low-power address is detected, R/W is a logic low, and the function codes have a five (101) on their output, the processor is writing to the low-power address in supervisor mode and user-designed circuitry should assert the ADDRESS_MATCH signal shown in Figure 2 and Figure 3.

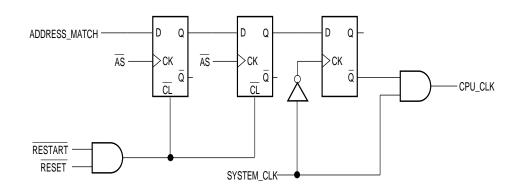


Figure 2. MC68SEC000 Low-Power Circuitry for 16-Bit Data Bus

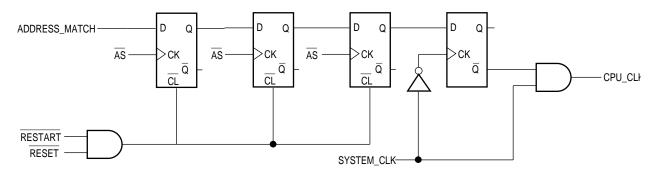


Figure 3. MC68SEC000 Low-Power Circuitry for 8-Bit Data Bus

2. Execute the STOP instruction. The external circuitry shown in Figure 2 and Figure 3 will count the number of bus cycles starting with the write to the low-power address and will stop the processor clock on the first falling edge of the system clock after the bus cycle that reads the immediate data of the STOP instruction. Figure 3 has one more flip-flop than Figure 2 because the MC68SEC000 in

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^{1.} The preliminary specification for the MC68SEC000's current drain while in the low-power mode is Idd < 2μ A for 3.3V operation and Idd < 5μ A for 5.0V operation.



8-bit mode requires two bus cycles to fetch the immediate data of the STOP instruction. After the processor clock is disabled, it is often necessary to disable the clock to other sections of your circuit. This can be done, but be careful that runt clocks and spurious glitches are not presented to the MC68SEC000. A timing diagram is shown in Figure 4.

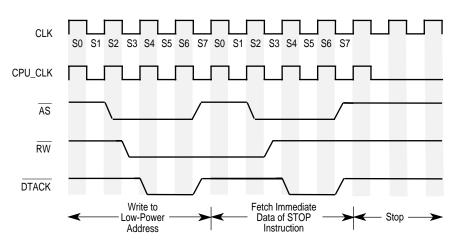
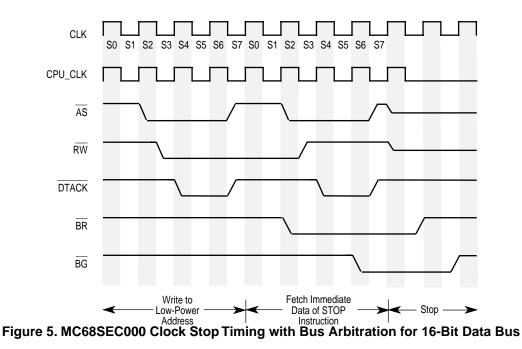


Figure 4. MC68SEC000 Clock Stop Timing for 16-Bit Data Bus

Note: While the MC68SEC000 is in the low-power mode, all inputs must be driven to V_{DD} or V_{SS} , or have a pull-up or pull-down resistor.

3. This step is optional depending on whether your applications require the MC68SEC000 signals with three-state capability to be placed into a high-impedance state. To place the MC68SEC000 into a three-state condition, the proper method for arbitrating the bus (as described in **5.2 Bus Arbitration** in the *M68000 User's Manual, Rev 8*) should be completed during the fetch of the status register data for the STOP instruction. A timing diagram with the bus arbitration sequence is shown in Figure 5.





An example trap routine is as follows:

- TRAP_x MOVE.B #0,\$low_power_address STOP #\$2000 RTE
- /* Write that causes ADDRESS_MATCH to assert */ /* STOP instruction with desired interrupt mask */ /* Return from the exception */

The first instruction (MOVE.B #0,\$low_power_address) writes a byte to the low-power address that will cause the external circuitry to begin the sequence that will stop the processor's clock. The second instruction (STOP #\$2000) loads the SR with the immediate data. This lets you set the interrupt that will cause the processor to come out of the low-power mode. The final instruction (RTE) tells the processor to return from the exception and resume normal processing.

3.0 MC68SEC000 ELECTRICAL SPECIFICATIONS

Add to the following table to Section 10.1.

3.1 MC68SEC000 MAXIMUM RATINGS

RATING	SYMBOL	VALUE	UNIT
Supply Voltage	V _{CC}	–0.3 to 6.5	V
Input Voltage	V _{in}	-0.5 to 6.5	V
Maximum Operating Temperature Range Commercial Extended "C" Grade	T _A	T _L to T _H 0 to 70 –40 to 85	°C
Storage Temperature	Tstg	-55 to 150	۵°

3.2 CMOS CONSIDERATIONS

The following change should be made to Section 10.4, CMOS Considerations.

"Although the MC68HC000 and MC68EC000 is implemented with input protection diodes, care should be exercised to ensure that the maximum input voltage specification is not exceeded." should read "Although the MC68HC000, MC68EC000, and MC68SEC000 are implemented with input protection diodes, be careful not to exceed the maximum input voltage specification."



5.0 MC68SEC000 DC ELECTRICAL SPECIFICATIONS

Add the following table to Section 10.13 on page 10-23.

(V_{CC} = 5.0 Vdc \pm 5%, 3.3 Vdc \pm 10%,; GND = 0 Vdc; T_A = T_L to T_H)

		3.:	3 V	5.0	V	
CHARACTERISTIC	SYMBOL	MIN	MAX	MIN	MAX	UNIT
Input High Voltage	V _{IH}	2.0	V _{CC}	2.0	V _{CC}	V
Input Low Voltage	V _{IL}	GND	0.8	GND - 0.5	0.8	V
Input Leakage Current BERR, BR, DTACK, CLK, TPL2-IPL0, AVEC MODE, HALT, RESET	lin	—	2.5 20	-	2.5 20	uA
Three-State (Off State) Input Current	I _{TSI}	—	2.5	—	2.5	uA
Output High Voltage	V _{OH}	2.4	—	V _{CC} -0.75		V
Output Low Voltage	V _{OL}					V
(IOL = 1.6 mA) HALT		—	0.5	-	0.5	
(IOL = 3.2 mA) A23–A0, BG, FC2–FC0		—	0.5	-	0.5	
(IOL = 5.0 mA) RESET		_	0.5	-	0.5	
$(IOL = 5.3 \text{ mA})$ AS, D15–D0, \overline{LDS} , R/W, \overline{UDS}		_	0.5	-	0.5	
Current Dissipation* f = 0 Hz	I _D	—	0.7	-	1.0	mA
f=10MHz		—	10	—	15	mA
f=16 MHz		—	15	—	25	mA
f= 20 MHz		_	20	_	30	mA
Capacitance (Vin = 0 V, T _A = 25 °C, Frequency = 1 MHz)**	Cin	—	20.0	-	20.0	pF
Load Capacitance HALT All Others	CL	—	70 130	-	70 130	pF

*During normal operation, instantaneous Vcc current requirements may be as high as 1.5A.

Currents listed are with no loading.

**Capacitance is periodically sampled rather than 100% tested.

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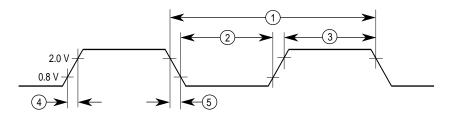


6.0 MC68SEC000 AC ELECTRICAL SPECIFICATIONS — CLOCK TIMING (See Figure 2)

Add the following table and Figure 8 to Section 10.9 on page 10-9.

			10MHz 16MHz		201	MHz			
NUM.	CHARACTERISTIC	SYMBOL	MIN	MAX	min	max	min	max	UNIT
	Frequency of Operation	f	0	10.0	0	16.7	0	20.0	MHz
1	Cycle time	tcyc	100	—	60	_	50	—	ns
2,3	Clock Pulse Width	t _{CL} t _{CH}	45 45	_	27 27	_	21 21	_	ns
4,5	Clock Rise and Fall Times	t _{Cr} t _{Cf}	_	10 10	_	5 5	_	4 4	ns

Applies to 3.3V and 5V.



NOTE: Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted. The voltage swing through this range should start outside and pass through the range such that the rise or fall will be linear between 0.8 V and 2.0 V.

Figure 8. MC68SEC000 Clock Input Timing Diagram



7.0 MC68SEC000 AC ELECTRICAL SPECIFICATIONS — READ AND WRITE CYCLES

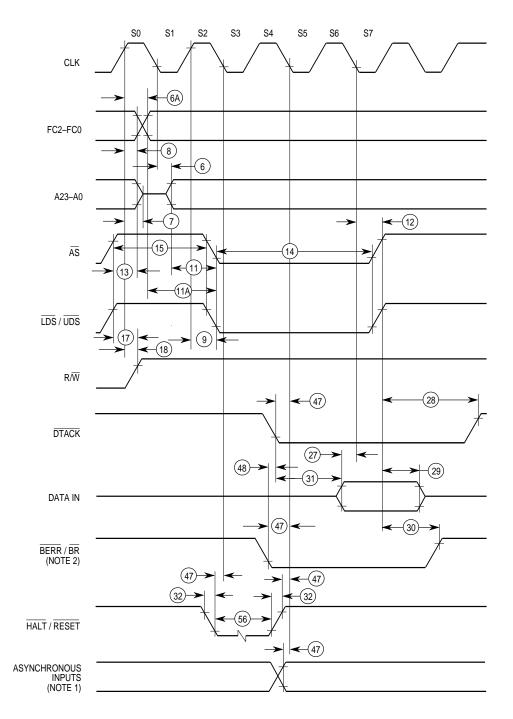
Add the following table and Figures 9 and 10 to Section 10.16.

Applies to 3.3V and 5V.

(GND = 0 V; $T_A = T_L$ to T_H ; see Figures 3 and 4)

		10	MHz	16	MHz	20	MHz	
NUM	CHARACTERISTIC		MAX	MIN	MAX	MIN	MAX	UNIT
6	Clock Low to Address Valid		35	_	30	—	25	ns
6A	Clock High to FC Valid	0	35	0	30	0	25	ns
7	Clock High to Address, Data Bus High Impedance (Maximum) (Write)		55	—	50	—	42	ns
8	Clock High to Address, FC Invalid (Minimum)	0	—	0	—	0	—	ns
9 ¹	Clock High to AS, LDS, UDS Asserted	3	35	3	30	3	25	ns
11 ²	Address Valid to $\overline{\text{AS}}$, $\overline{\text{LDS}}$, $\overline{\text{UDS}}$ Asserted (Read)/ $\overline{\text{AS}}$ Asserted (Write)	20	-	15	—	10	-	ns
11A ²	FC Valid to AS, LDS, UDS Asserted (Read)/ AS Asserted (Write)	45	-	45	—	40	_	ns
12 ¹	Clock Low to AS, LDS, UDS Negated	3	35	3	30	3	25	ns
13 ²	AS, LDS, UDS Negated to Address, FC Invalid	15	_	15	—	10	_	ns
14 ²	AS (and LDS, UDS Read) Width Asserted		-	120	—	100	-	ns
14A ²	LDS, UDS Width Asserted (Write)	95	-	60	_	50	-	ns
15 ²	AS, LDS, UDS Width Negated	105	-	60	_	50	-	ns
16	Clock High to Control Bus High Impedance	_	55	_	50	_	42	ns
17 ²	AS, LDS, UDS Negated to R/W Invalid	15	-	15	—	10	-	ns
18 ¹	Clock High to R/W High (Read)	0	35	0	30	0	25	ns
20 ¹	Clock High to R/W Low (Write)	0	35	0	30	0	25	ns
20A ^{2,6}	AS Asserted to R/W Low (Write)		10	_	10	_	10	ns
21 ²	Address Valid to R/W Low (Write)	0	-	0	—	0	-	ns
21A ²	FC Valid to R/W Low (Write)	50	-	30	_	25	-	ns
22 ²	R/W Low to DS Asserted (Write)	50	-	30	_	25	-	ns
23	Clock Low to Data-Out Valid (Write)	_	35	_	30	_	25	ns
25 ²	AS, LDS, UDS Negated to Data-Out Invalid (Write)	30	-	15	—	10	-	ns
26 ²	Data-Out Valid to LDS, UDS Asserted (Write)	30	-	15	—	10	-	ns
27 ⁵	Data-In Valid to Clock Low (Setup Time on Read)	5	-	5	—	5	-	ns
28 ²	AS, LDS, UDS Negated to DTACK Negated (Asynchronous Hold)	0	110	0	110	0	95	ns
28A	Clock High to DTACK Negated	0	110	0	110	0	95	ns





NOTES:

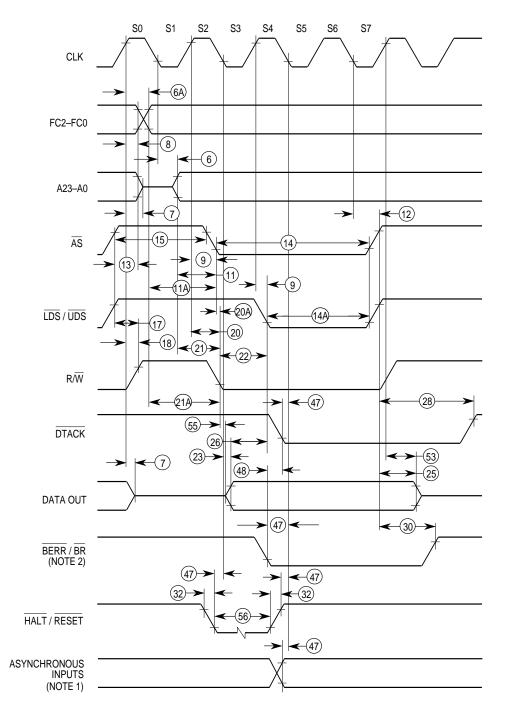
- 1. Setup time for the asynchronous inputs IPL2–IPL0 and AVEC (#47) guarantees their recognition at the next falling edge of the clock.
- 2. BR need fall at this time only to insure being recognized at the end of the bus cycle.
- 3. Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted. The voltage swing through this range should start outside and pass through the range such that the rise or fall is linear between 0.8 V and 2.0 V.

Figure 9. MC68SEC000 Read Cycle Timing Diagram

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NOTES:

- 1. Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted. The voltage swing through this range should start outside and pass through the range such that the rise or fall is linear between 0.8 V and 2.0 V.
- 2. Because of loading variations, R/W may be valid after AS even though both are initiated by the rising edge of S2 (specification #20A).



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8.0 MC68SEC000 AC ELECTRICAL SPECIFICATIONS — BUS ARBITRATION

Add the following table and Figure 11 to Section 10.17.

(GND = 0 Vdc; $T_A = T_L$ to T_H ; refer to Figure 13)

NUM				16N	/Hz	201	ЛНz	UNIT
NOW	CHARACTERISTICP		MAX	MIN	MAX	MIN	MAX	
7	Clock High to Address, Data Bus High Impedance (Maximum)	—	55	—	50	—	42	ns
16	Clock High to Control Bus High Impedance	—	55	—	50	—	42	ns
33	Clock High to BG Asserted		35	0	30	0	25	ns
34	Clock High to BG Negated		35	0	30	0	25	ns
35	BR Asserted to BG Asserted		3.5	1.5	3.5	1.5	3.5	Clks
36	BR Negated to BG Negated		3.5	1.5	3.5	1.5	3.5	Clks
38	BG Asserted to Control, Address, Data Bus High Impedance (AS Negated)		55	—	50	_	42	ns
39	BG Width Negated	1.5	—	1.5	—	1.5	—	Clks
47	Asynchronous Input Setup Time		—	5	—	5	—	ns
58 ¹	BR Negated to AS, LDS, UDS, R/W Driven		—	1.5	—	1.5	—	Clks
58A ¹	BR Negated to FC Driven	1	—	1	—	1	—	Clks

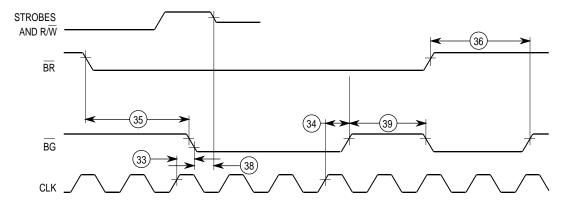
Applies to 3.3V and 5V.

1. The minimum value must be met to guarantee proper operation. If the maximum value is exceeded, BG may be reasserted.



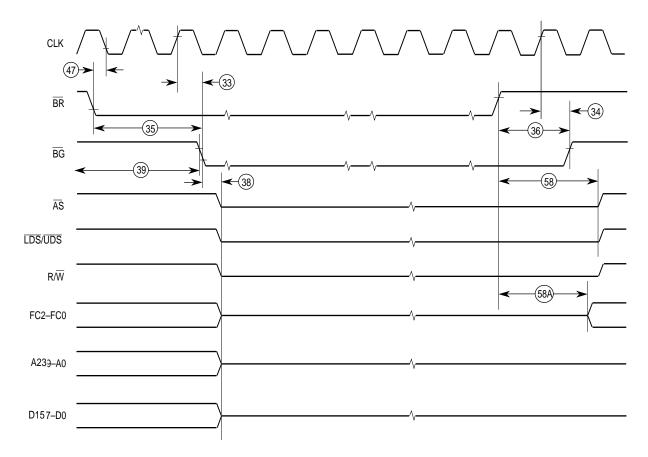
Semiconductor, Inc.

Freescale



NOTE: Setup time to the clock (#47) for the asynchronous inputs BERR, BR, DTACK, IPL2-IPL0, and VPA guarantees their recognition at the next falling edge of the clock.

Figure 11. Bus Arbitration Timing

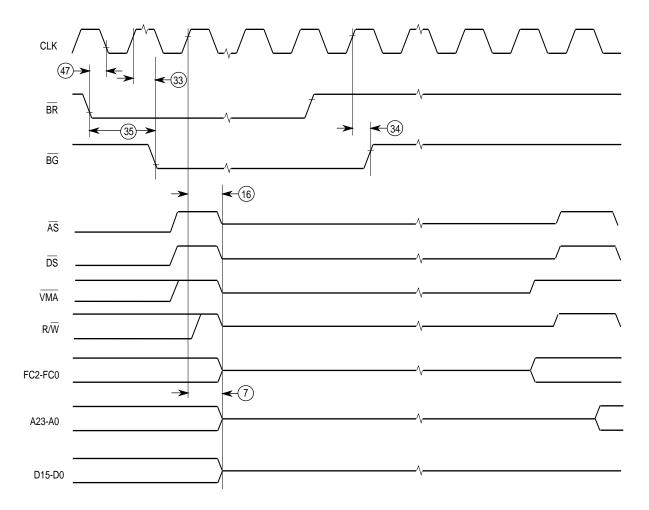


NOTE: Waveform measurements for all inputs and outputs are specified at: logic high 2.0 V, logic low = 0.8 V.

Figure 12. MC68SEC000 Bus Arbitration Timing Diagram

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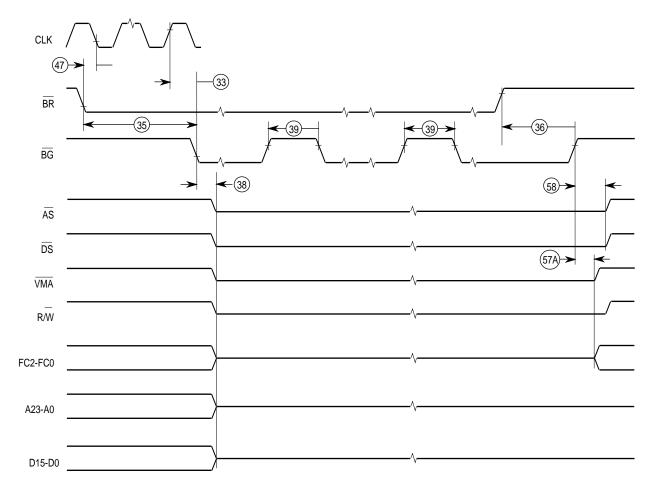




NOTE: Waveform measurements for all inputs and outputs are specified at: logic high 2.0 V, logic low = 0.8 V. This diagram also applies to the 68EC000.

Figure 14. Bus Arbitration Timing - Active Bus Case





NOTES: Waveform measurements for all inputs and outputs are specified at: logic high 2.0 V, logic low = 0.8 V. This diagram also applies to the 68EC000.

Figure 15. Bus Arbitration - Multiple Bus Request

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9.0 MECHANICAL DATA

9.1 PIN ASSIGNMENTS

Add Figure 12 to Section 11.1.

The following defines the pin assignment and the package dimensions of the 64 lead QFP (FU package) and 64 lead TQFP (PB package) for the MC68SEC000. Note that it is pin-to-pin compatible with the MC68EC000.

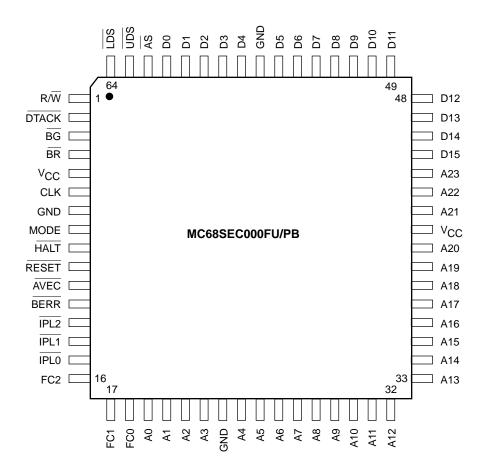


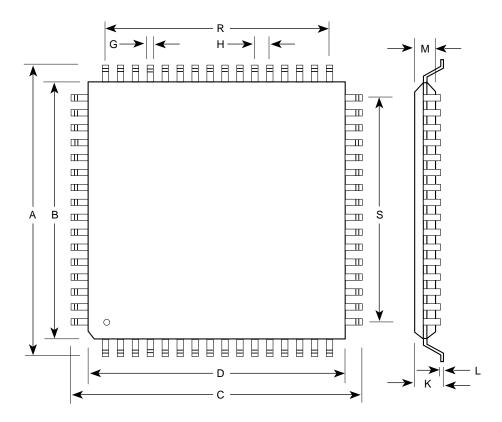
Figure 16. 64-Lead Quad Flat Pack and 64-Lead Thin Quad Flat Pack



10.0 PACKAGE DIMENSIONS - FU SUFFIX

This diagram replaces the one on Page 11-16

64 Lead Quad Flat Pack Case 840B-01



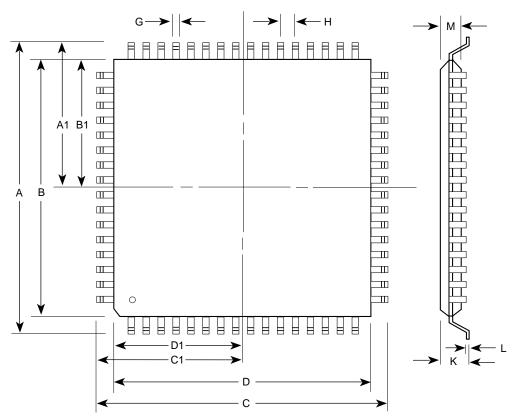
DIM	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	16.95	17.45	0.667	0.687	
В	13.90	14.10	0.547	0.555	
С	16.95	17.45	0.667	0.687	
D	13.90	14.10	0.547	0.555	
G	0.30	0.45	0.012	0.018	
Н	0.80	BSC	0.031 BSC		
K	2.15	2.45	0.085	0.096	
L	0.13	0.23	0.005	0.009	
М	2.00	2.40	0.79	0.094	
R	12.00	REF	0.472 REF		
S	12.00	REF	0.472	REF	



11.0 PACKAGE DIMENSIONS - PB SUFFIX

Add the following to Section 11.2.

64 Lead Thin Quad Flat Pack Case 840F-02



DIM	MILLI	METERS	INC	HES	
DIN	MIN	MAX	MIN	MAX	
A	12.00	BSC	0.472 BSC		
A1	6.00	BSC	0.236 BSC		
В	10.00	BSC	0.394 BSC		
B1	5.00	BSC	0.197 BSC		
С	12.00	BSC	0.472 BSC		
C1	6.00	BSC	0.236 BSC		
D	10.00	BSC	0.394 BSC		
D1	5.00	BSC	0.197 BSC		
G	0.17	0.27	0.007	0.011	
Н	0.50	BSC	0.020	BSC	
K	1.60			0.063	
L	0.09	0.20	0.004	0.008	
М	1.35	1.45	0.053	0.057	



ORDERING INFORMATION

Add the following to Section 11.

The following tables contains the ordering information for the MC68SEC000.

MC68SEC000 Ordering Information

PACKAGE	BODY SIZE	LEAD SPACING	SPEED (IN MH Z)	VOLTAGE	SUFFIX	TEMPERATURE RANGE
	44.0	0.0			FU	0C to +70C
QFP	14.0 mm X 14.0mm	0.8mm	10/16/20 MH-	3.3V or 5.0V	CFU	-40C to +85C
тогр	40.0	0.5	10/16/20 MHz	3.30 01 5.00	PB	0C to +70C
TQFP	10.0mm x 10.0mm	0.5mm			CPB	-40C to +85C

MC68HC000 Ordering Information

PACKAGE	BODY SIZE	LEAD SPACING	SPEED (IN MHZ)	VOLTAGE	SUFFIX	TEMPERATURE RANGE
DIP	81.91mm X 20.57mm	2.54mm	8, 10, 12, 16		Р	0C to +70C
PLCC	05 57 V 05 07	4.07	8, 10, 12, 16, 20	5.0V	FN	0C to +70C
	25.57mm X 25.27mm	1.27mm	8, 10, 12, 16		CFN	-40C to +85C

MC68EC000 Ordering Information

PACKAGE	BODY SIZE	LEAD SPACING	SPEED (IN MHZ)	VOLTAGE	SUFFIX	TEMPERATURE RANGE
PLCC	25.57mm X 25.27mm	1.27mm	8, 10,12, 16, 20	5.0V	FN	0C to +70C
PQFP	14.1mm X 14.1mm	0.8mm	8, 10,12, 16, 20		FU	

DOCUMENTATION

Add to Section 11.

The documents listed in the following table contain detailed information that pertain to the MC68SEC000 processor. You can obtain these documents from the Literature Distribution Centers listed on the last page of this document.

MC68SEC000 Documentation

MC68SEC000 DOCUMENTATION	DOCUMENT NUMBER
M68000 Family Programmer's Reference Manual	M68000PM/AD
M68000 User's Manual	M68000UM/AD
High Performance Embedded Systems Source Catalog"	BR729/D
MC68EC000 Product Brief	MC68EC000/D
MC68SEC000 Product Brief	MC68SEC000/D



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